


PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1
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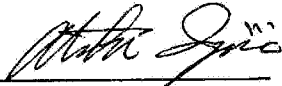
EPAS ID: PAT5394723

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
WEI XIONG	02/22/2019
ATSUSHI IJIMA	02/22/2019
RECEIVING PARTY DATA	
Name:	SAE MAGNETICS (H.K.) LTD.
Street Address:	SAE TECHNOLOGY CENTRE, 6 SCIENCE PARK EAST AVENUE, HONG KONG SCIENCE PARK, SHATIN, N.T.
City:	HONG KONG
State/Country:	HONG KONG
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	16136227
CORRESPONDENCE DATA	
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<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
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ATTORNEY DOCKET NUMBER:	SHIRAI-1803-USPT
NAME OF SUBMITTER:	CHARLES HO
SIGNATURE:	/Charles Ho/
DATE SIGNED:	02/26/2019
Total Attachments: 2	
source=Executed assignment#page1.tif	
source=Executed assignment#page2.tif	

ASSIGNMENT - Patent Application		Docket Number: SHIRAI-1803-USPT
Whereas, the Assignor, comprising the following named inventors:		
ASSIGNOR(s)/ INVENTOR(s)	Wei Xiong and Atsushi Iijima	
made an invention entitled: <u>Thin-film Piezoelectric-material Element, Method of Manufacturing the Same, Head Gimbal Assembly and Hard Disk Drive</u>		
for which an application for Letters Patent of the United States: (Select one of the following):		
<input type="checkbox"/> is executed concurrently herewith		
<input checked="" type="checkbox"/> was filed in the U.S. Patent and Trademark Office on <u>September 19, 2018</u> , as U.S. Patent Application Serial No.: <u>16/136,227</u>		
ASSIGNEE (Full Name, Address and Country)	SAE Magnetics (H.K.) Ltd. SAE Technology Centre, 6 Science Park East Avenue, Hong Kong Science Park, Shatin, N.T. Hong Kong	
<p>is desirous of acquiring our entire right, title and interest in and to said invention and the Letters Patent to be obtained therefor,</p> <p>Now, therefore, in consideration of the payment by Assignee to Assignor of a sum corresponding to One Dollar (\$1.00), and for other good and valuable consideration, the receipt of which is hereby acknowledged, Assignor, intending to be legally bound, hereby sells, assigns and transfers to Assignee, its successors and assigns, the full and exclusive right, title and interest in and to said invention, all applications for Letters Patent for said invention, including all divisions, continuations, and continuations-in-part thereof, all rights to claim priority based thereon, and all Letters Patent, including reissues, to be obtained therefor, including any and all foreign patent rights in this invention corresponding thereto.</p> <p>Assignor hereby warrants that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this Assignment.</p> <p>Assignor agrees it shall be legally bound, upon request of the Assignee or its successors or assigns or a legal representative thereof, to supply all information and evidence of which the Assignor has knowledge or possession, relating to the making and practice of said invention, to testify in any legal proceeding relating thereto, to execute all instruments proper to patent the invention in the United States of America and foreign countries in the name of the Assignee, and to execute all instruments proper to carry out the intent of this instrument.</p> <p>In witness whereof, this Assignment is executed on the day indicated below.</p>		

	Typed or Printed Name	Signature	Date
SIGNATURE	Wei Xiong	X 	X Feb 22, 2019

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	Typed or Printed Name	Signature	Date
SIGNATURE	Atsushi Iijima	X 	X <u>22/Feb/2019</u>